IGBT - Field Stop II

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage. **Features**

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- This is a Pb–Free Device

Typical Applications

- Solar Inverter
- Uninterruptible Power Supplies (UPS)
- Welding

ABSOLUTE	MAXIMUM	RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _c	60 30	A
Pulsed collector current, T_{pulse} limited by T_{Jmax} , 10 μ s Pulse, V_{GE} = 15 V	I _{CM}	120	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	60 30	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	120	A
Gate-emitter voltage Transient gate-emitter voltage $(T_{pulse} = 5 \ \mu s, D < 0.10)$	V_{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	452 227	W
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, $T_J \leq 150^\circ C$	T _{SC}	10	μS
Operating junction temperature range	ТJ	-55 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

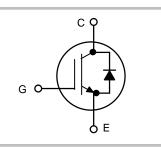
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

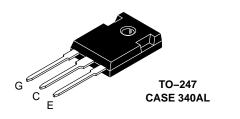


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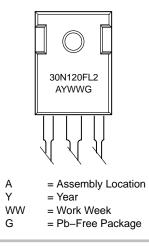
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30 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 0.7 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB30N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

Semiconductor Components Industries, LLC, 2015
 July, 2015 – Rev. 1

THERMAL CHARACTERISTICS

Rating		Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.33	°C/W
Thermal resistance junction-to-case, for Diode		0.5	°C/W
Thermal resistance junction-to-ambient	R_{\thetaJA}	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

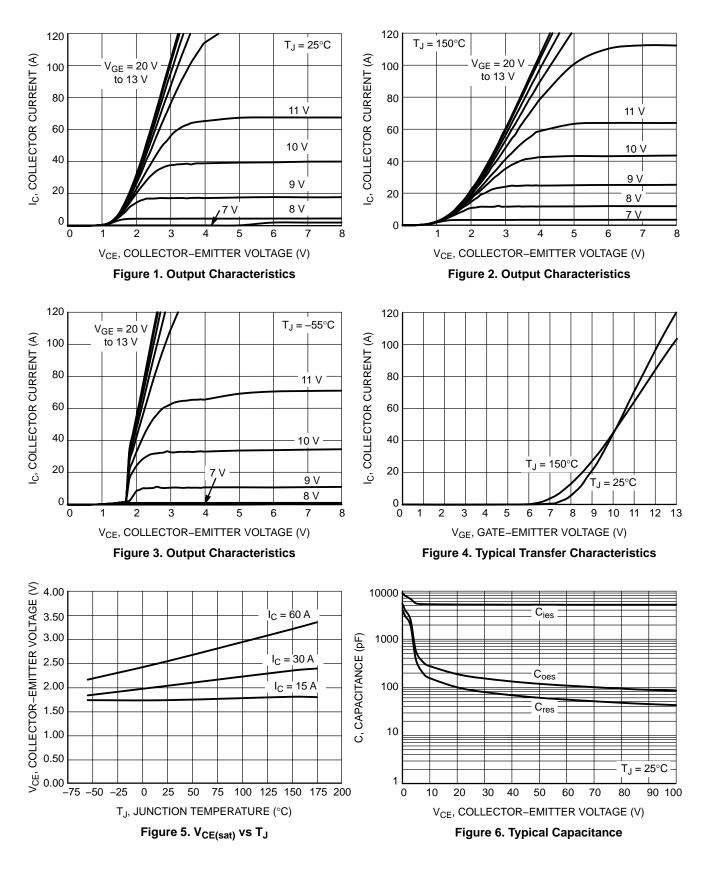
Parameter	Test Conditions	Symbol	Min	Тур	Мах	Unit
STATIC CHARACTERISTIC	•		-		-	
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1200	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 30 A V_{GE} = 15 V, I _C = 30 A, T _J = 175°C	V _{CEsat}	_ _	2.00	2.30 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J=} 175^{\circ}C$	ICES	-	-	1.0 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	-	200	nA

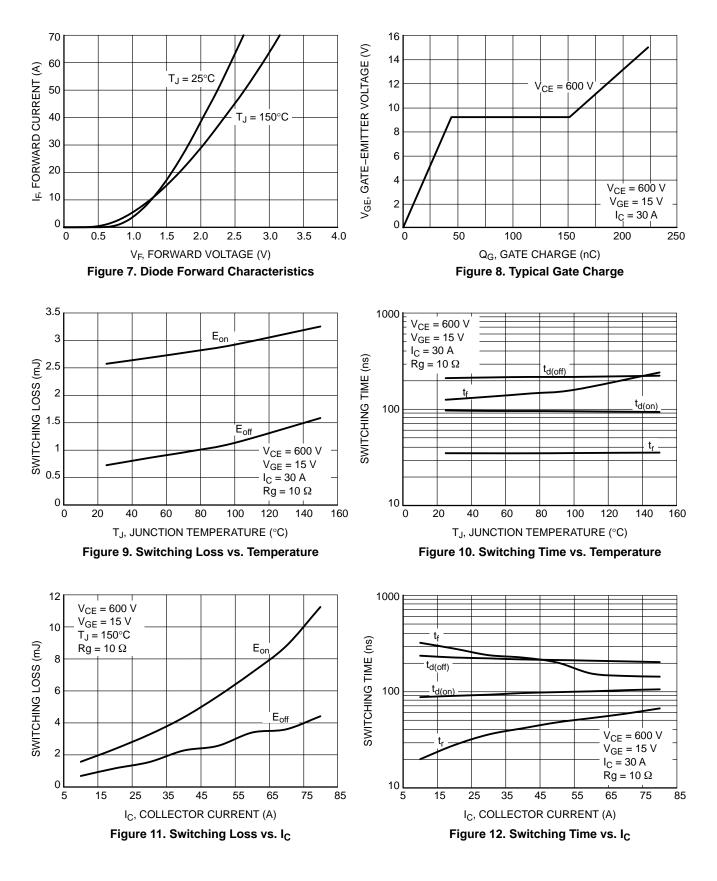
Input capacitance		Cies	-	5250	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	Coes	-	170	-	
Reverse transfer capacitance		C _{res}	-	100	-	
Gate charge total		Qg	-	220	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 30 A, V _{GE} = 15 V	Q _{ge}	-	45	-	
Gate to collector charge		Q _{gc}	-	105	-	

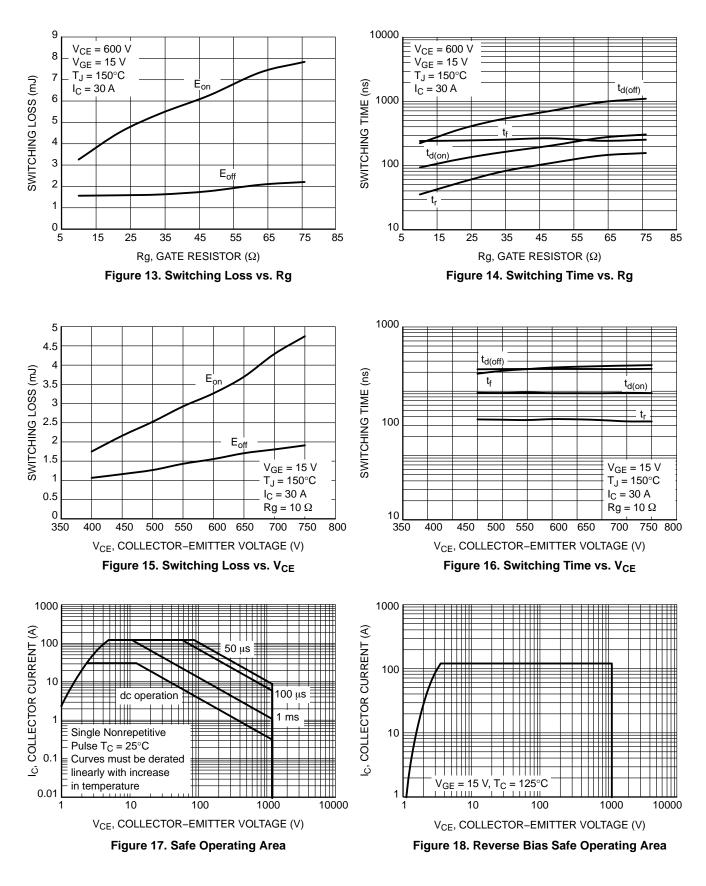
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

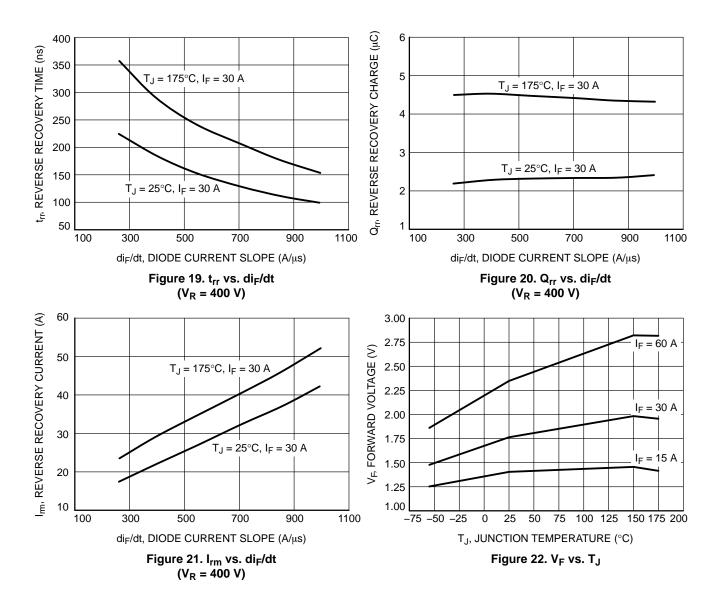
Turn-on delay time		t _{d(on)}	-	98	-	ns
Rise time		t _r	-	35	-	
Turn-off delay time	$T_J = 25^{\circ}C$ $V_{CC} = 600 V, I_C = 30 A$	t _{d(off)}	_	210	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 30 \text{ A}$	t _f	-	130	-	
Turn-on switching loss	$R_g = 10 \Omega$ V _{GE} = 0 V/ 15V	Eon	-	2.6	-	mJ
Turn-off switching loss		E _{off}	-	0.7	-	
Total switching loss		E _{ts}	-	3.3	-	
Turn-on delay time		t _{d(on)}	-	92	-	ns
Rise time		t _r	-	35	-	1
Turn-off delay time	T _J = 175°C	t _{d(off)}	-	220	-	1
Fall time	$T_{J} = 175^{\circ}C$ $V_{CC} = 600 \text{ V, } I_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t _f	-	260	-	1
Turn-on switching loss	V _{GE} = 0 V/ 15V	Eon	-	3.5	-	mJ
Turn-off switching loss		E _{off}	-	1.8	-	1
Total switching loss		E _{ts}	_	5.3	-	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 30 A V _{GE} = 0 V, I _F = 30 A, T _J = 175°C	V _F		1.75 -		V
Reverse recovery time	T ₁ = 25°C	t	_	240	_	ns

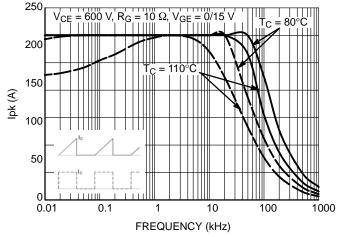
Forward voltage	V _{GE} = 0 V, I _F = 30 A V _{GE} = 0 V, I _F = 30 A, T _J = 175°C	VF	-	1.75 -	-	V
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}	-	240	-	ns
Reverse recovery charge	I _F = 30 Å, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}	-	2.5	-	μC
Reverse recovery current		Irrm	-	18	I	А
Reverse recovery time	$T_{\rm J} = 175^{\circ}{\rm C}$	t _{rr}	-	413	I	ns
Reverse recovery charge	I _F = 30 A, V _R = 400 V di _F /dt = 200 A/us	Q _{rr}	-	4.3	-	μC
Reverse recovery current		I _{rrm}	_	20	I	А

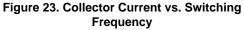


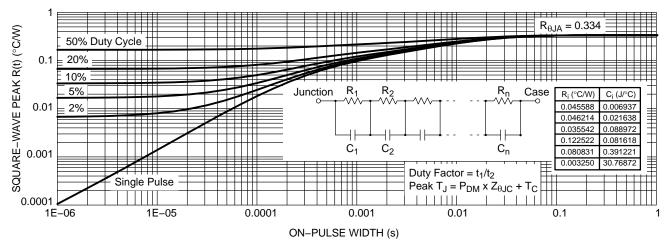


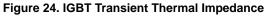


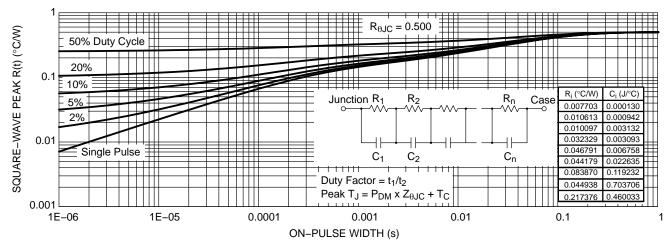










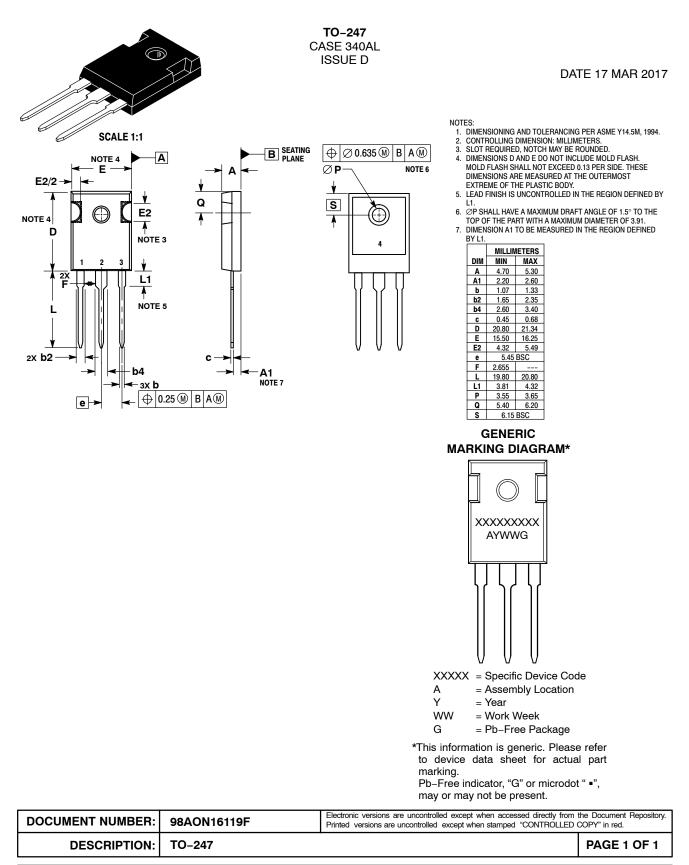




MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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